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Vishay/Siliconix SI4178DY-T1-E3

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Si4178DY-T1-E3

Vishay Siliconix

N-Channel 30 V (D-S) MOSFET

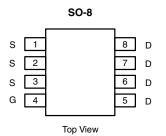
PRODUCT SUMMARY					
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
30	0.021 at V _{GS} = 10 V	12 ^a	3.7 nC		
	0.033 at V _{GS} = 4.5 V	6	5.7 110		

FEATURES

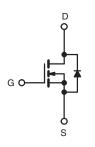
- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Notebook System Power
- Low Current DC/DC



Ordering Information: Si4178DY-T1-E3 (Lead (Pb)-free)



N-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		V _{DS}	30	V	
Gate-Source Voltage		V _{GS}	± 25		
	T _C = 25 °C		12 ^a		
Continuous Drain Current ($T_1 = 150 \ ^{\circ}C$)	T _C = 70 °C		9.7 ^a		
Continuous Drain Current $(1) = 150^{\circ}$ C)	T _A = 25 °C	U	8.3 ^{b, c}		
	T _A = 70 °C		6.7 ^{b, c}	Α	
Pulsed Drain Current		I _{DM}	40	A	
Continuous Source-Drain Diode Current	T _C = 25 °C		4.2		
	T _A = 25 °C	Is —	2 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	10		
Single Pulse Avalanche Energy		E _{AS}	5	mJ	
	T _C = 25 °C		5		
Maximum Power Discipation	T _C = 70 °C	P _D	3.2	w	
Maximum Power Dissipation	T _A = 25 °C		2.4 ^{b, c}	vv	
	T _A = 70 °C	1	1.5 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	42	53	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	19	25	0/11		

Notes:

a. Package limited.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 10 s.

d. Maximum under steady state conditions is 85 $^{\circ}\text{C/W}.$

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SPECIFICATIONS ($T_J = 25 \degree C$) Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Symbol	Test conditions		тур.	IVIAX.	Unit	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = 250 μA	30	T	1	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$			25		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = 250 \ \mu A$	1.4	Ŭ	2.8	v	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, \text{ V}_{GS} = \pm 25 \text{ V}$	1.4		± 100	nA	
Cale-Oburce Leakage	'688	$V_{\rm DS} = 30$ V, $V_{\rm GS} = 0$ V			± 100	11/4	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			10	μA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 V, V_{GS} = 10 V$	20			А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 8.4 \text{ A}$		0.017	0.021		
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 2 \text{ A}$		0.027	0.033	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 8.4 A		22		S	
Dynamic ^b			I	1	I		
Input Capacitance	C _{iss}			405		pF	
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		110			
Reverse Transfer Capacitance	C _{rss}			56			
Total Gate Charge	Qg	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 8.4 \text{ A}$		7.5	12	nC	
	∽g			3.7	5.6		
Gate-Source Charge	Q _{gs}	$V_{DS} = 15$ V, $V_{GS} = 4.5$ V, $I_{D} = 8.4$ A		1.6			
Gate-Drain Charge	Q _{gd}			1.3			
Gate Resistance	Rg	f = 1 MHz	0.5	2.6	5.2	Ω	
Turn-On Delay Time	t _{d(on)}			20	30	-	
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		15	25		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 6.7$ A, V_{GEN} = 4.5 V, R_g = 1 Ω		11	20		
Fall Time	t _f			10	15	ne	
Turn-On Delay Time	t _{d(on)}			7	15	- ns	
Rise Time	t _r	V_{DD} = 15 V, R_L = 2.2 Ω		10	15		
Turn-Off Delay Time	t _{d(off)}	$\rm I_D \cong 6.7$ A, $\rm V_{GEN}$ = 10 V, $\rm R_g$ = 1 Ω		12	20		
Fall Time	t _f			10	15	Ī	
Drain-Source Body Diode Characteristi	cs						
Continuous Source-Drain Diode Current	۱ _S	$T_{C} = 25 \ ^{\circ}C$			4.2	A	
Pulse Diode Forward Current	I _{SM}				40	~	
Body Diode Voltage	V _{SD}	$I_{S} = 6.7 \text{ A}, V_{GS} = 0 \text{ V}$		0.85	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 6.7 A, dl/dt = 100 A/μs, T _{.1} = 25 °C		8	16	nC	
Reverse Recovery Fall Time	t _a	$F = 0.7 \text{ A}, \text{ unut} = 100 \text{ A/}\mu\text{s}, T_{\text{J}} = 25 \text{ C}$		8.5			
Reverse Recovery Rise Time	rerse Recovery Rise Time t _b			6.5		ns	

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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°C

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T_C =

4

20

= 8.4 A

٩

100

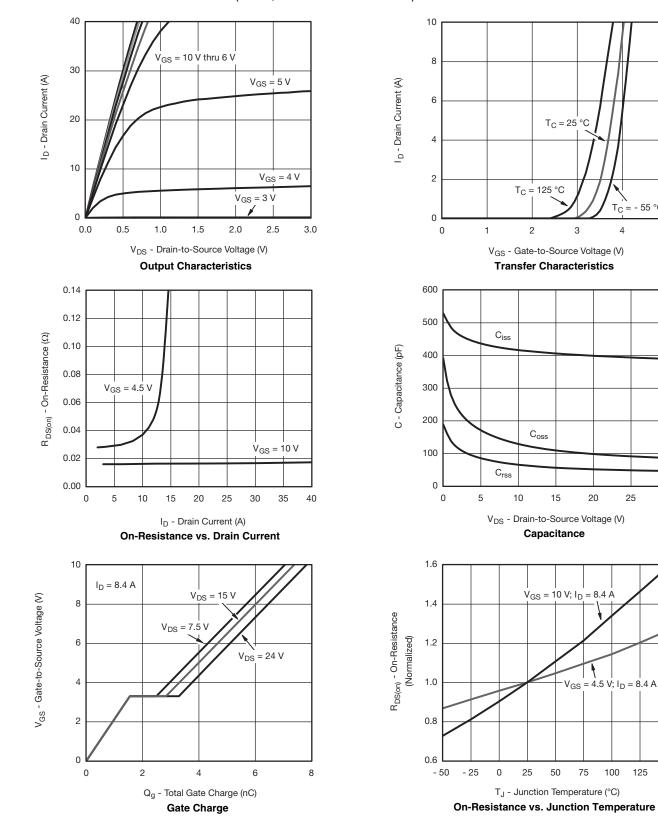
75

25

30

55 °C

5



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

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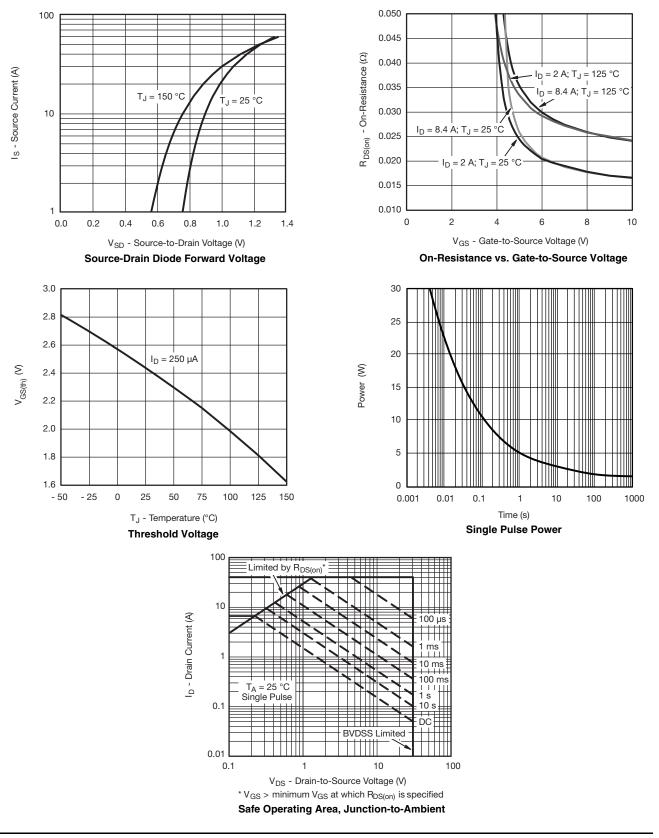


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



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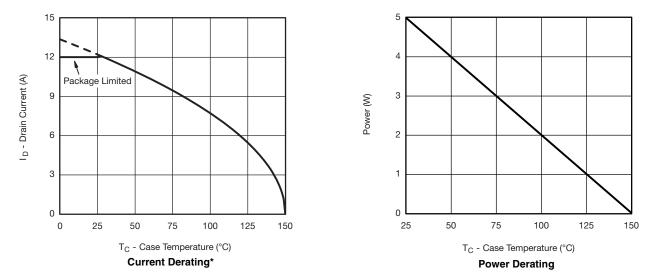
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

* The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

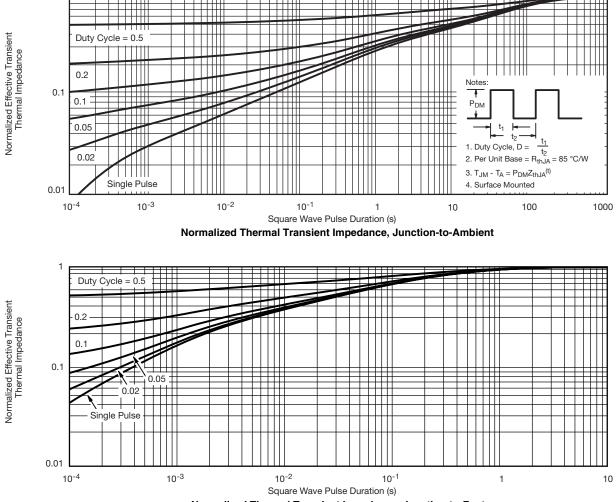


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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations.

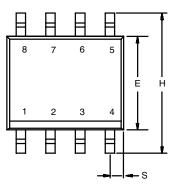


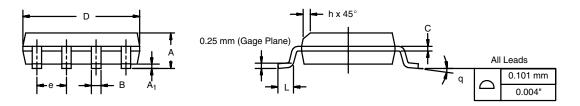


Package Information

Vishay Siliconix

SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INCHES		
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

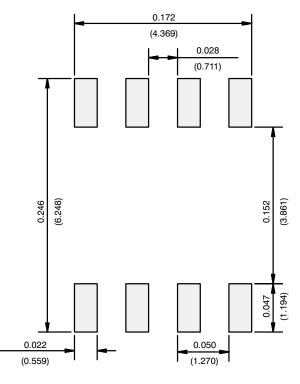


Application Note 826

Vishay Siliconix



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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